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AP: LCP U TAINLESS CONDUC	STEEL									F
CONDUCTIVE COPPER ALLOY ACTS: 0.75 MICRON MIN GOLD OVER 1.27 MICRON MIN NICKEL 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL DARD PIN DRAWINGS E BASED ON 1.58MM BOARD THICKNESS): VING 2032633080-SD, MIN. MATING DISTANCE 6.7MM F DRAWING 2032630001-SD, MIN. MATING DISTANCE 6.9MM 10UNT DRAWING 2032634185-SD, MIN. MATING DISTANCE 9.9MM										E
CATION: 2043130001-PS CIFICATION: 2043130001-AS SPEC FOR SOLDERING INFORMATION. FICATION: 2043650000-PK NTS WILL BE SUPPLIED TARNISH FREE OVER TIME. AP TO BE REMOVED AFTER SOLDERING. OUT OF BOTTOM FROM THE TOP. LASER MARKED APPROXIMATELY WHERE SHOWN MAT										C
ON THAT IS PROPRI ENT REV DESC: U		CHNOLOGIES,	NOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
0: 747243 8.0MM SENTRALITY BOTTOM ENTRY SMT SOCKET WITH FLOAT IN T&R   N: SACHIK7 2023/02/28   D: SCS02 2023/04/25   R: HTHYAGARAJ 2023/04/26   PRODUCT CUSTOMER DRAWING   AL REVISION: DOCUMENT NUMBER   N: RLOW 2019/10/03									REVISIO	
R: BPISZCZOR ANGLE PROJECTION	DRAWING	2019/10/03 2019/10/04 SERIES 212195	212 MATERIAL NUI 21219	MBER	010-SC		PSD		B3 NUMBER	